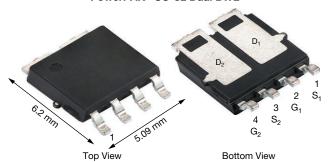


Vishay Siliconix

# Automotive Dual N-Channel 40 V (D-S) 175 °C MOSFET

### PowerPAK® SO-8L Dual BWL

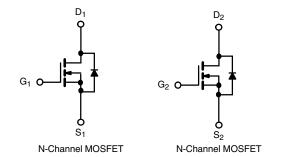


PRODUCT SUMMARY			
V <sub>DS</sub> (V)	40		
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.00688		
I <sub>D</sub> (A) per leg <sup>e</sup>	72		
Configuration	Dual		

### **FEATURES**

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ORDERING INFORMATION	
Package	PowerPAK® SO-8L
Lead (Pb)-free and halogen-free	SQJ748EP (for detailed order number please see <a href="https://www.vishay.com/doc?79771">www.vishay.com/doc?79771</a> )

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	40	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
Continuous Drain Current <sup>e</sup>	T <sub>C</sub> = 25 °C <sup>a</sup>		72		
	T <sub>C</sub> = 125 °C	- I <sub>D</sub>	41		
Continuous Source Current (Diode conduction) e		I <sub>S</sub>	72	А	
Pulsed Drain Current b, e		I <sub>DM</sub>	54		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	17.5		
Single Pulse Avalanche Energy	L=0.11IIII	E <sub>AS</sub>	15	mJ	
Maximum Power Dissipation <sup>b, e</sup>	T <sub>C</sub> = 25 °C	D	66	W	
	T <sub>C</sub> = 125 °C	P <sub>D</sub>	22		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering Recommendations (Peak temperature) d, e			260		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB mount <sup>c</sup>	$R_{thJA}$	52	°C/W	
Junction-to-Case (Drain) d	oction-to-Case (Drain) <sup>d</sup>		2.3	C/VV	

#### **Notes**

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. When mounted on 1" square PCB (FR4 material)
- c. See solder profile (<a href="https://www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- d. As per JESD51-14
- e. Values based on  $R_{thJC}$  and  $T_C$  of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system



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PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40	-	-	V
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		2.8	3.5	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
Zero Gate Voltage Drain Current		$V_{GS} = 0 V$	$V_{DS} = 40 V$		-	1	
	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, T_{J} = 125  ^{\circ}\text{C}$	-	-	50	μΑ
		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 175 °C	-	-	150	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	10	-	-	Α
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 7 A	-	0.0057	0.00688	Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}$	I <sub>D</sub> = 7 A, T <sub>J</sub> = 125 °C	-	-	0.0105	
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 7 A, T <sub>J</sub> = 175 °C	-	-	0.0126	
Forward Transconductance b	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A		-	47	-	S
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>		V <sub>DS</sub> = 25 V, f = 1 MHz	-	878	1230	pF
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	275	385	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	35	49	
Total Gate Charge <sup>c</sup>	$Q_g$			-	14	21	nC
Gate-Source Charge c	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{DS} = 20 \text{ V}, I_{D} = 15 \text{ A}$	-	5	-	
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			-	3	-	
Gate Resistance	$R_g$	f = 1 MHz		2.1	4.3	6.5	Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>				10	15	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 1.33 $\Omega$ $I_D \cong$ 15 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		-	4	8	ns ns
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	15	23	
Fall Time <sup>c</sup>	t <sub>f</sub>			-	4	8	
Source-Drain Diode Ratings and Char	acteristics <sup>b</sup>						
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	134	Α
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> = 7 A, V <sub>GS</sub> = 0 V		-	0.88	1.2	V
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 10 A, di/dt = 100A/us		-	20	40	ns
Body diode reverse recovery charge	Q <sub>rr</sub>			-	8	16	nC
Reverse recovery fall time	ta			-	9	-	ns
Reverse recovery rise time	t <sub>b</sub>			-	11	-	
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-0.7	-	Α

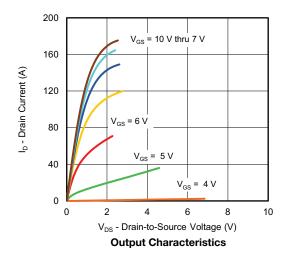
### **Notes**

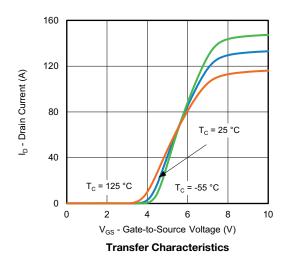
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

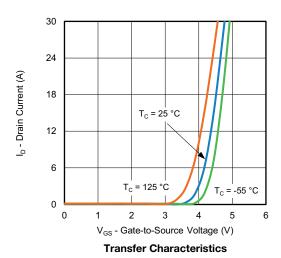
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

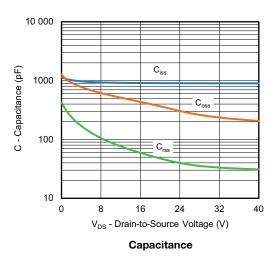


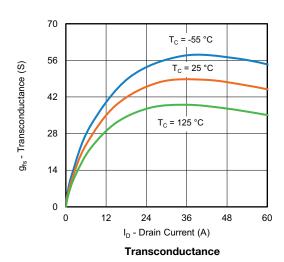
## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

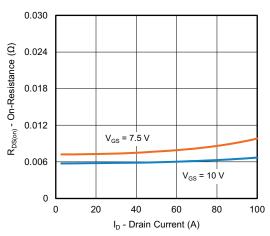








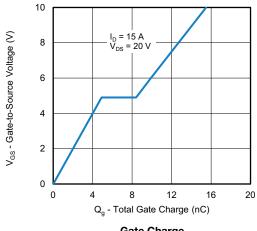




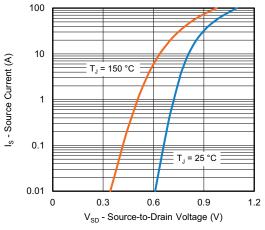
For technical questions, contact: automostech



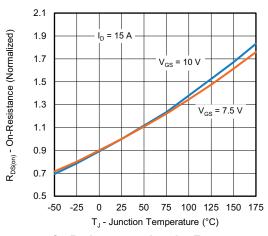
### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



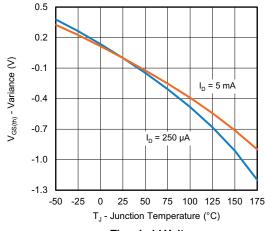
**Gate Charge** 



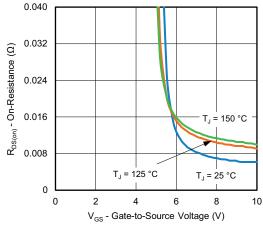
**Source Drain Diode Forward Voltage** 



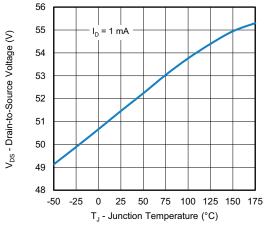
On-Resistance vs. Junction Temperature



**Threshold Voltage** 



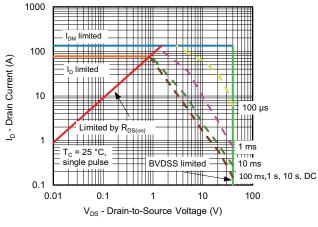
On-Resistance vs. Gate-to-Source Voltage



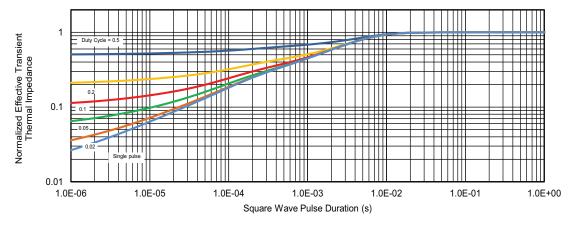
Drain Source Breakdown vs. Junction Temperature



## **THERMAL RATINGS** ( $T_A = 25$ °C, unless otherwise noted)



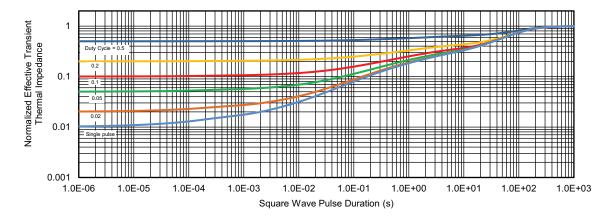
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case



### THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



### Normalized Thermal Transient Impedance, Junction-to-Ambient

#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg262213">www.vishay.com/ppg262213</a>.



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